OPGA SCHOLARSHIP PROGRAM

Purpose

The purpose of the Ohio Propane Gas Association Scholarship is to foster education, to be of increased service to all Association members, to enhance the public image of the propane industry, and to provide financial assistance to selected individuals who are seeking education beyond high school.

Standards

The following standards will apply to all OPGA Scholarship funds applicants:

- A) Applicants must be high school seniors or undergraduate students.
- B) Applicants must be a **dependent child** of an employee of a member of the Ohio Propane Gas Association. The parent's work must be directly related to the propane industry. The OPGA member must be in good standing with the Ohio Propane Gas Association.
- C) Applicants must be full time residents of the State of Ohio.
- D) Applicants must be registered to attend an accredited college, university, or vocational school for the purpose of obtaining an academic degree.
- E) Applicants who have completed one or more college terms must submit grade point average for the most recent term completed.
- F) Distribution of scholarship funds will be made directly to the recipient's college, university, or vocational school.
- G) The Committee is committed to award a maximum of two \$1,000 Scholarships at the 2018 Ohio Propane Gas Association Summer Meeting August 5-7, 2018 at The Hilton Polaris Hotel in Columbus, Ohio. Recipient will also receive a one room/night complimentary accommodations (if needed) and dinner for self and two guests.

 Award winners' attendance is mandatory at the banquet that will be held the evening of August 6, 2018.
- H) Application deadline is April 15, 2018. Application must be **RECEIVED** in the OPGA office by this date.
- I) The OPGA Scholarship Committee strives to assist as many young scholars as possible. **Past scholarship recipients are not eligible to receive the award again.**

OHIO PROPANE GAS ASSOCIATION SCHOLARSHIP APPLICATION FORM

DEADLINE FOR SUBMISSION: April 15, 2018

Name of applicant		_
Mailing address		
City	State	Zip
Phone	E-mail	
High School attending or sc	chool last attended	_
Last grade completed	Date of High Schoo	l Graduation
University/College you will	be attending	
Enrollment Date		
Major		
You must be a <mark>dependant child</mark> a Association to receive this Schol		npany of the Ohio Propane Gas
Name of Company		
Address		
City	StateZip co	ode
Email of President or Manager		
Printed Name of President or Manaş	ger	
Signature of President or Manager_		
Date		

Applications, including three letters of recommendations, school transcript, essay, and job experience/resume should be mailed to:

OPGA Scholarship Application 605 N. High Street, #214 Columbus, OH 43215

Applicant Name:	_
Please specify how scholarship, if awarded, will be used:	
Industry Information: Name of parent employed in the propane industry	
His/her job description	
Number of years in the propane industry	

	Cerences: Please list three teachers, counselors, we your potential for succeeding in your planned education.	vork supervisors and /or employers who can comment acational experience.	
#1)	Name of reference		
Tit	e or position	Telephone number	
Em	ail Address		
#2)	Name of reference		
Tit	le or position	Telephone number	
Em	ail Address		
#3)	Name of reference		
		Telephone number	
Email Address			
	School Transcript - a complete official school (College) must be included with this application.	eve to be considered for this Scholarship. Your reasons	
a) Past academic achievement b) How you have demonstrated initiative and responsibility c) How you have demonstrated consistent effort and performance d) Financial need e) Extracurricular activities and interests f) Volunteer activities g) Awards and Honors received			
4)	Resume - list any Academic Achievements, job experiences, Volunteer Activities, Extracurricular Activities, Awards and Honors you have received or participated in.		
	e information supplied above is for use in applying rue and accurate to the best of my knowledge.	g for the Scholarship offered. All information herewith	
Ap	plicant's Signature	Date	